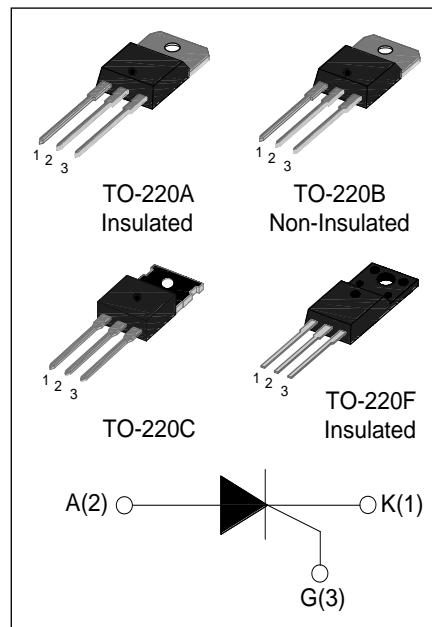


**DESCRIPTION:**

JCT1025/1225 series of silicon controlled rectifiers, with high ability to withstand the shock loading of large current, provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc.

JCTxx25A provides insulation voltage rated at 2500V RMS and JCTxx25F provides insulation voltage rated at 2000V RMS from all three terminals to external heatsink. JCT1225A and JCT1225F series comply with UL standards (File ref: E252906).

**MAIN FEATURES**

Symbol	JCT1025	JCT1225
$V_{DRM}/ V_{RRM}$	1000V	1200V
$I_{T(RMS)}$	25A	
$I_{GT}$		$\leq 40\text{mA}$

**ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Value	Unit
Storage junction temperature range	$T_{stg}$	-40-150	°C
Operating junction temperature range	$T_j$	-40-125	°C
Repetitive peak off-state voltage( $T_j=25^\circ\text{C}$ )	$V_{DRM}$	1000/1200	V
Repetitive peak reverse voltage( $T_j=25^\circ\text{C}$ )	$V_{RRM}$	1000/1200	V
Non repetitive surge peak Off-state voltage	$V_{DSM}$	$V_{DRM} + 100$	V
Non repetitive peak reverse voltage	$V_{RSM}$	$V_{RRM} + 100$	V
RMS on-state current	$I_{T(RMS)}$	25	A
	TO-220A (Ins)/ TO-220F (Ins) ( $T_c=85^\circ\text{C}$ )		
	TO-220B (Non-Ins)/ TO-220C ( $T_c=100^\circ\text{C}$ )		



Non repetitive surge peak on-state current (tp=10ms)	I <sub>TSM</sub>	300	A
I <sup>2</sup> t value for fusing (tp=10ms)	I <sup>2</sup> t	450	A <sup>2</sup> s
Critical rate of rise of on-state current (I <sub>G</sub> =2×I <sub>GT</sub> )	dI/dt	150	A/μs
Peak gate current	I <sub>GM</sub>	4	A
Average gate power dissipation	P <sub>G(AV)</sub>	2	W
Peak gate power	P <sub>GM</sub>	5	W

### ELECTRICAL CHARACTERISTICS (T<sub>j</sub>=25°C unless otherwise specified)

Symbol	Test Condition	Value			Unit
		MIN.	TYP.	MAX.	
I <sub>GT</sub>	V <sub>D</sub> =12V R <sub>L</sub> =33Ω	-	-	40	mA
V <sub>GT</sub>		-	-	1.5	V
V <sub>GD</sub>	V <sub>D</sub> =V <sub>DRM</sub> T <sub>j</sub> =125°C R <sub>L</sub> =3.3KΩ	0.2	-	-	V
I <sub>L</sub>	I <sub>G</sub> =1.2I <sub>GT</sub>	-	-	120	mA
I <sub>H</sub>	I <sub>T</sub> =500mA	-	-	100	mA
dV/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =125°C	1000	-	-	V/μs

### STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V <sub>TM</sub>	I <sub>TM</sub> =50A tp=380μs	T <sub>j</sub> =25°C	1.6	V
I <sub>DRM</sub>	V <sub>D</sub> =V <sub>DRM</sub> V <sub>R</sub> =V <sub>RRM</sub>	T <sub>j</sub> =25°C	10	μA
I <sub>RRM</sub>		T <sub>j</sub> =125°C	4	mA

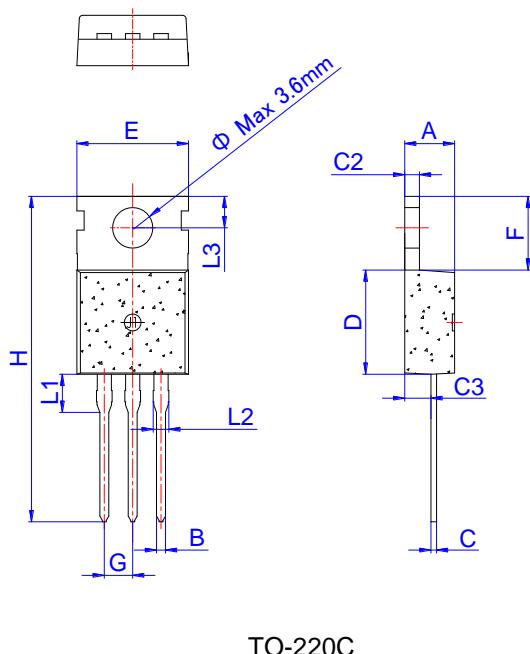
### THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R <sub>th(j-c)</sub>	junction to case(AC)	TO-220A(Ins) / TO-220F(Ins)	1.9
		TO-220B (Non-Ins)/ TO-220C	1.0

## ORDERING INFORMATION

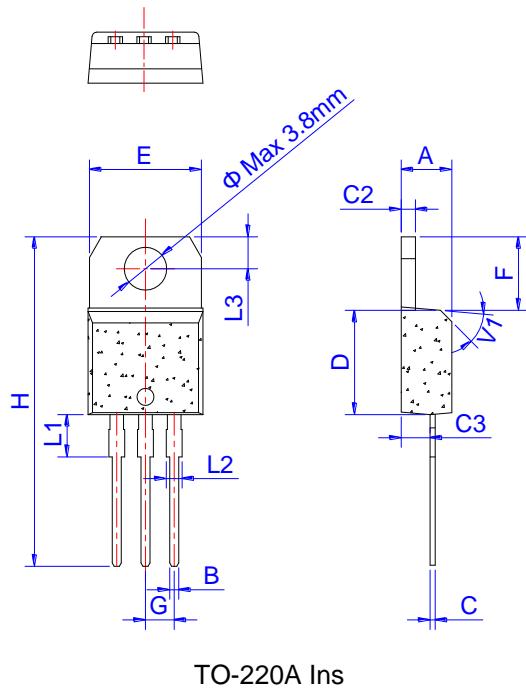
J	CT	12	25	B
JieJie Microelectronics Co.,Ltd				
	SCRs			
				C:TO-220C A:TO-220A(Ins) F:TO-220F(Ins) B:TO-220B (Non-Ins)
		10:V <sub>DRM</sub> / V <sub>RRM</sub> ≥ 1000V 12:V <sub>DRM</sub> / V <sub>RRM</sub> ≥ 1200V		I <sub>T(RMS)</sub> :25A

## PACKAGE MECHANICAL DATA

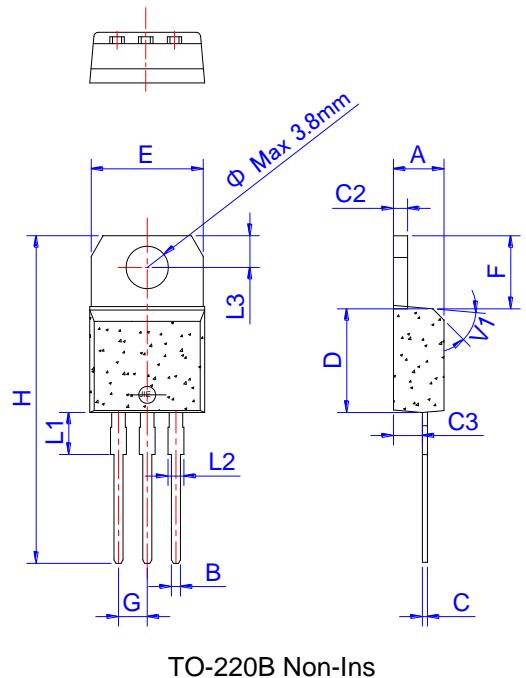


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.70		0.90	0.028		0.035
C	0.45		0.60	0.018		0.024
C2	1.23		1.32	0.048		0.052
C3	2.20		2.60	0.087		0.102
D	8.90		9.90	0.350		0.390
E	9.90		10.3	0.390		0.406
F	6.30		6.90	0.248		0.272
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.39			0.133	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
Φ		3.6			0.142	

## PACKAGE MECHANICAL DATA

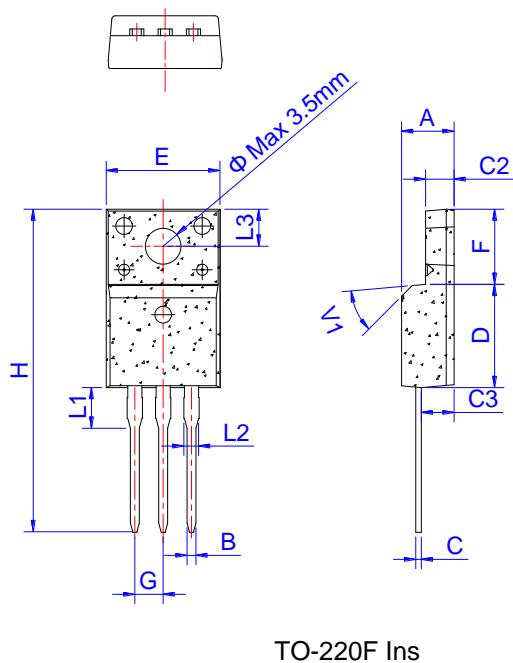


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.61		0.88	0.024		0.035
C	0.46		0.70	0.018		0.028
C2	1.21		1.32	0.048		0.052
C3	2.40		2.72	0.094		0.107
D	8.60		9.70	0.339		0.382
E	9.80		10.4	0.386		0.409
F	6.55		6.95	0.258		0.274
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.75			0.148	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
V1		45°			45°	



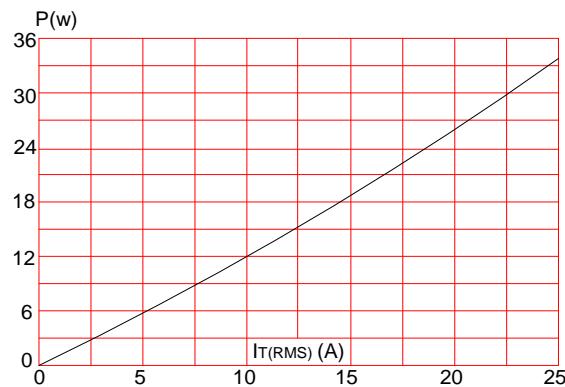
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.61		0.88	0.024		0.035
C	0.46		0.70	0.018		0.028
C2	1.21		1.32	0.048		0.052
C3	2.40		2.72	0.094		0.107
D	8.60		9.70	0.339		0.382
E	9.60		10.4	0.378		0.409
F	6.20		6.60	0.244		0.260
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.75			0.148	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
V1		45°			45°	

## PACKAGE MECHANICAL DATA

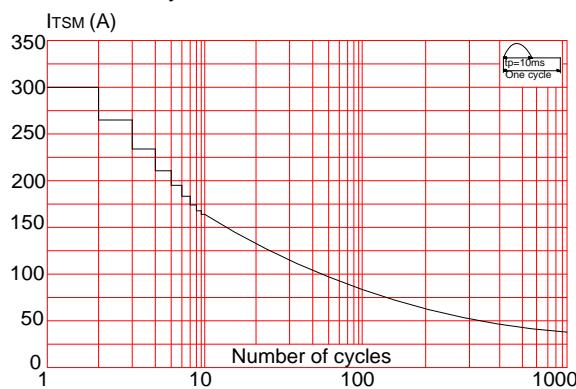


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.80	0.173		0.189
B	0.74	0.80	0.83	0.029	0.031	0.033
C	0.48		0.75	0.019		0.030
C2	2.40		2.70	0.094		0.106
C3	2.60		3.00	0.102		0.118
D	8.80		9.30	0.346		0.366
E	9.70		10.3	0.382		0.406
F	6.40		7.00	0.252		0.276
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.63			0.143	
L2	1.14		1.70	0.045		0.067
L3		3.30			0.130	
V1		45°			45°	

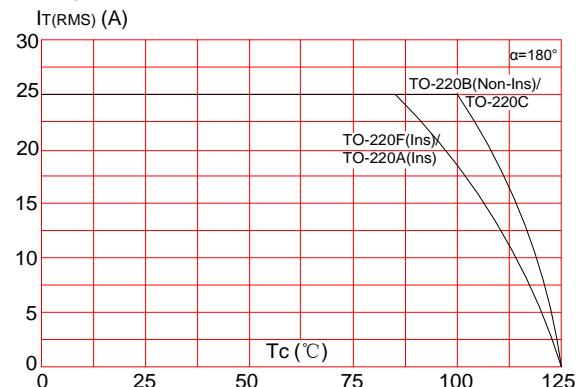
**FIG.1** Maximum power dissipation versus RMS on-state current



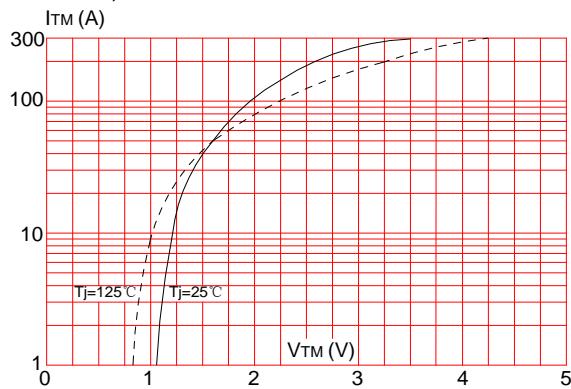
**FIG.3:** Surge peak on-state current versus number of cycles



**FIG.2:** RMS on-state current versus case temperature

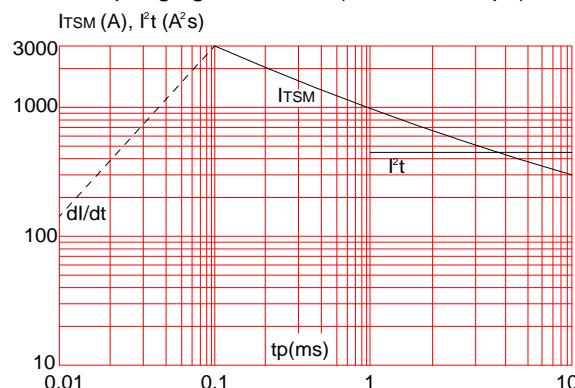


**FIG.4:** On-state characteristics (maximum values)

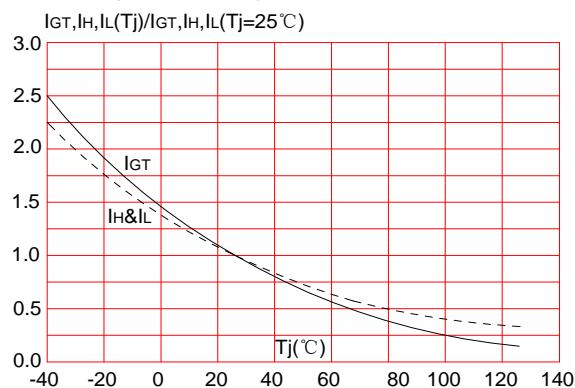




**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10\text{ms}$ , and corresponding value of  $\dot{I}^2t$  ( $dI/dt < 150\text{A}/\mu\text{s}$ )



**FIG.6:** Relative variations of gate trigger current, holding current and latching current versus junction temperature



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